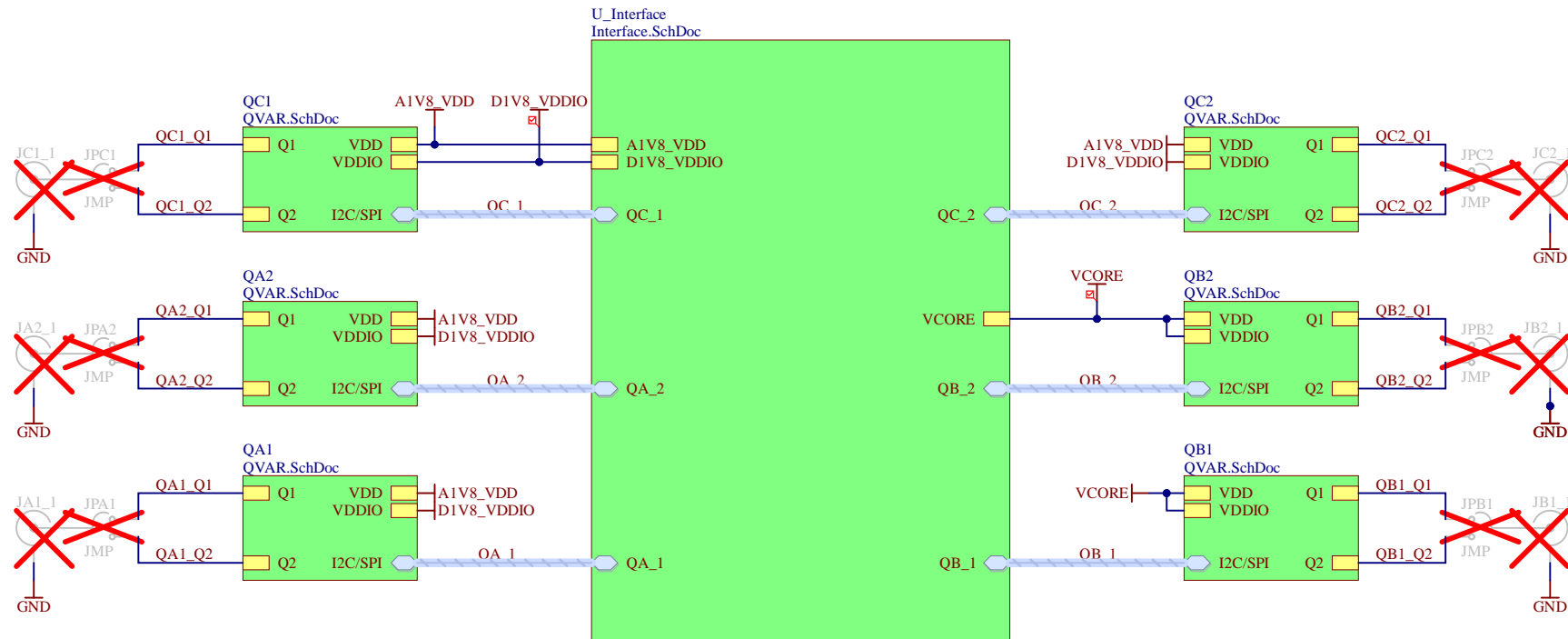
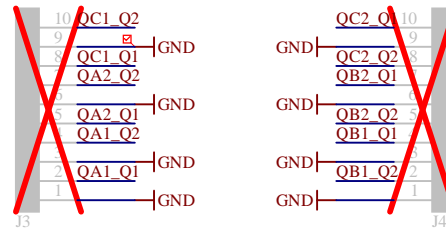
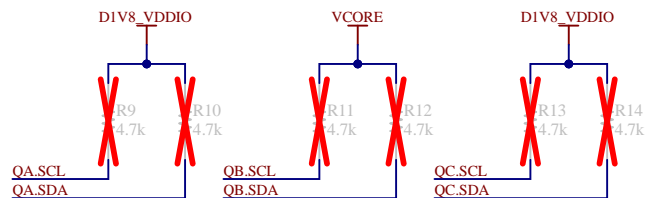
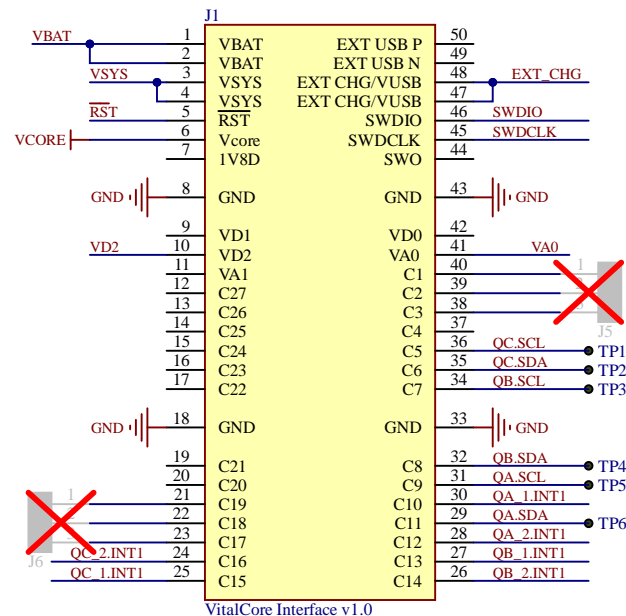
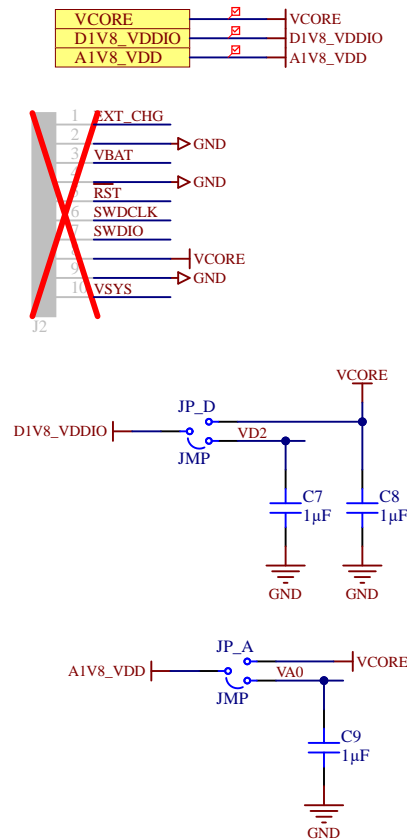
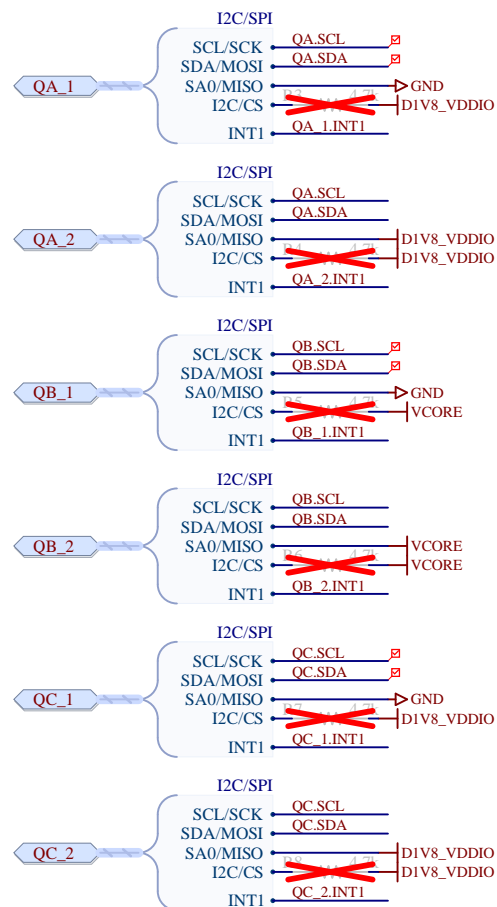


the 2 QVAR attached to I2CB have to be supplied by VCORE!



the 2 QVAR attached to I2CB have to be supplied by VCORE, as the I2CB interface is used by the PMIC for configuration on the vitalcore

SWDIO and SWDCLK have to be connected externally in an ideal case. For emergency requirements a solderpad is supplied



**ETH**  
Eidgenössische Technische Hochschule Zürich  
Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL, IIS

Date: 17/11/2023 17:55:23

Rev: 1.0

Variation: Fabrication

File: Interface.SchDoc

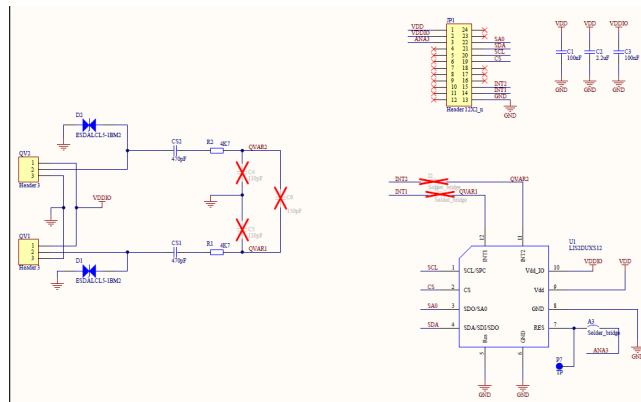
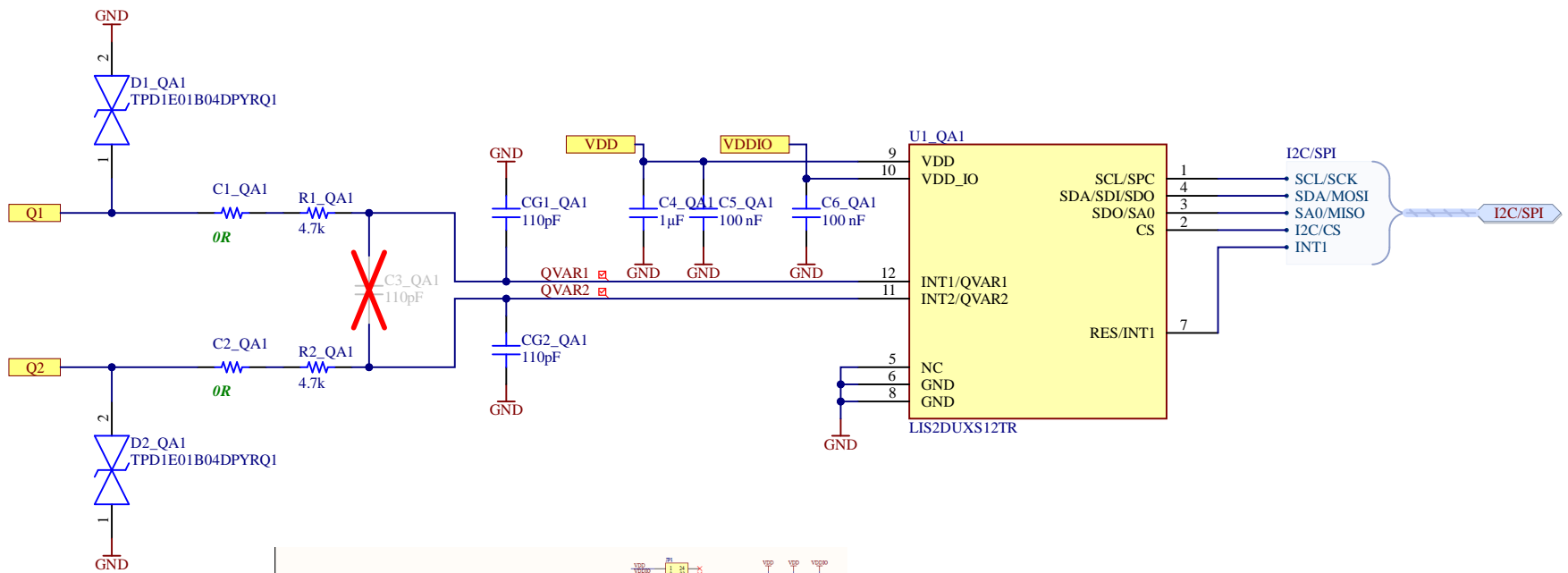
Project: Qvar 6 Channel Vitalcore Backpack

**VitalCore Interface**

Drawn By: villanif

Checked By: topolonelli, nschae, peterste

Sheet: 2 / 3



**ETH**

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Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL, IIS

Date: 17/11/2023 17:55:23

Rev: 1.0

Variation: Fabrication

File: QVAR.SchDoc

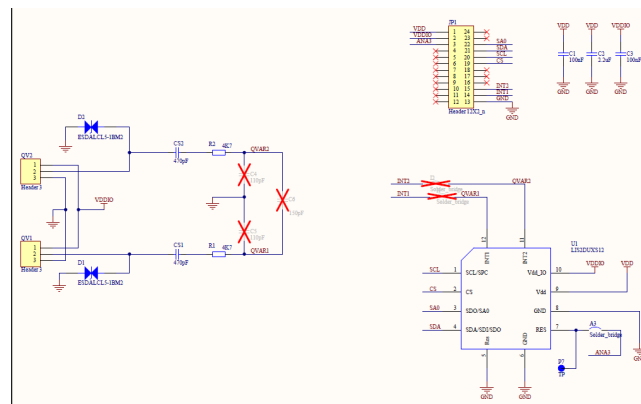
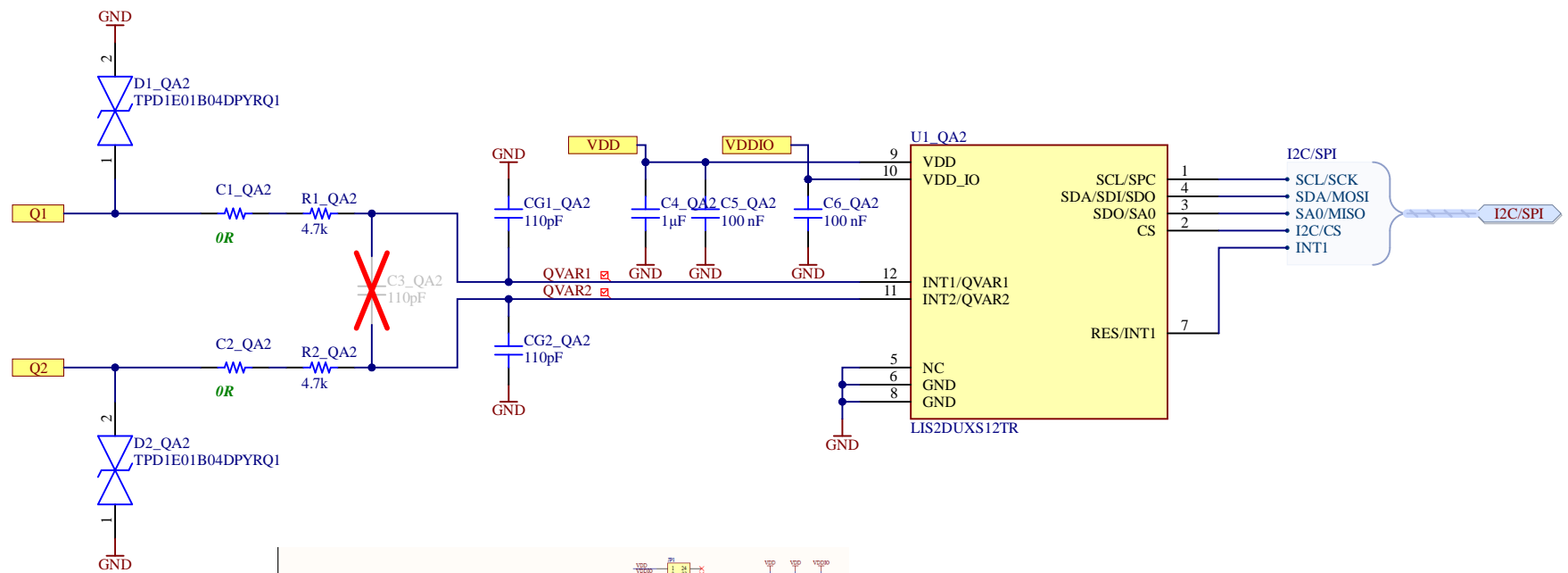
Project: Qvar 6 Channel Vitalcore Backpack

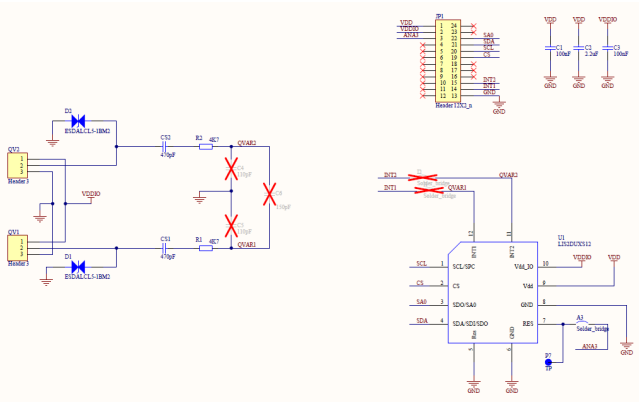
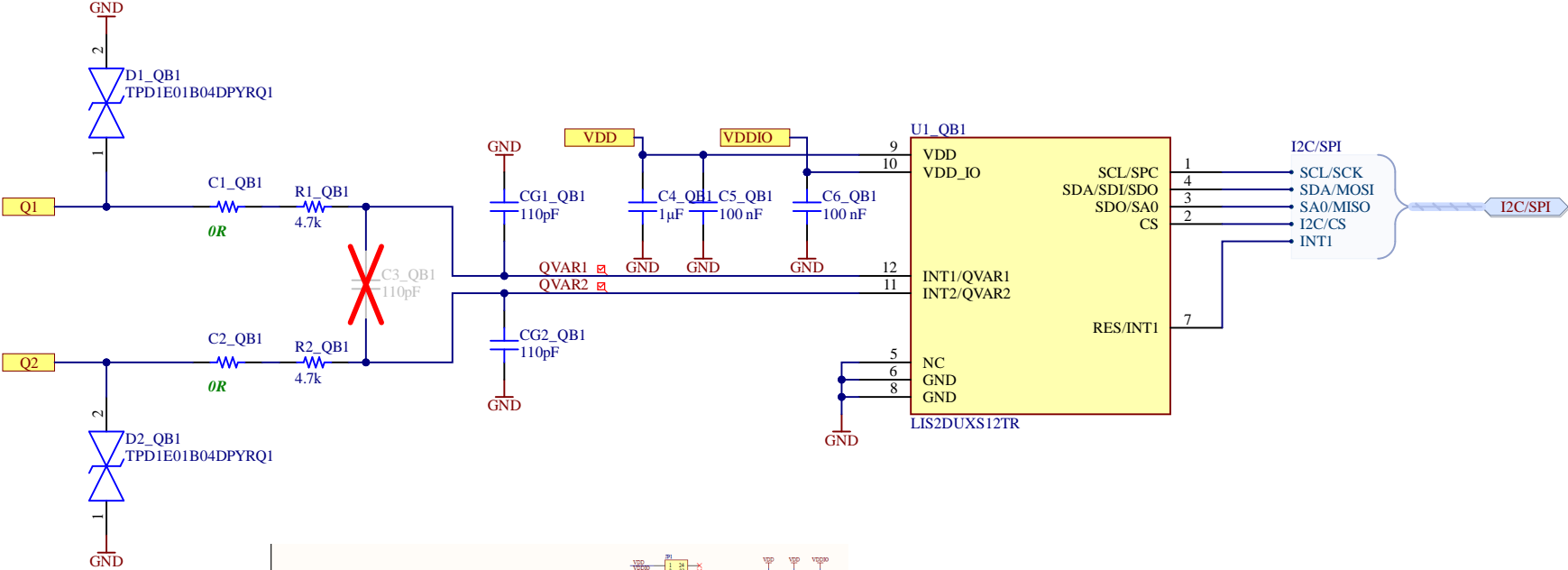
**QVAR sensor**

Drawn By: villanif

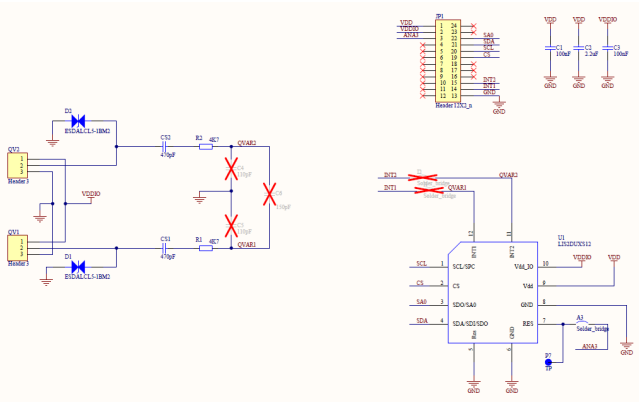
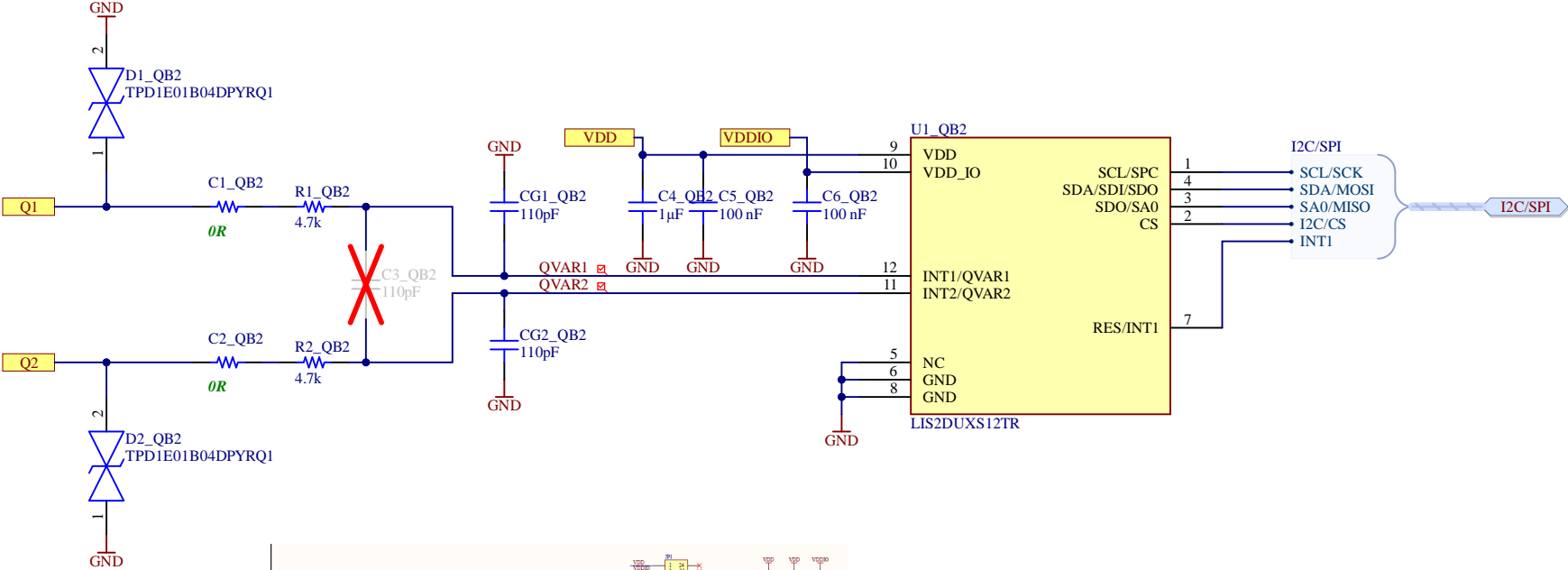
Checked By: topononelli, nschae, peterste

Sheet: 3 / 3

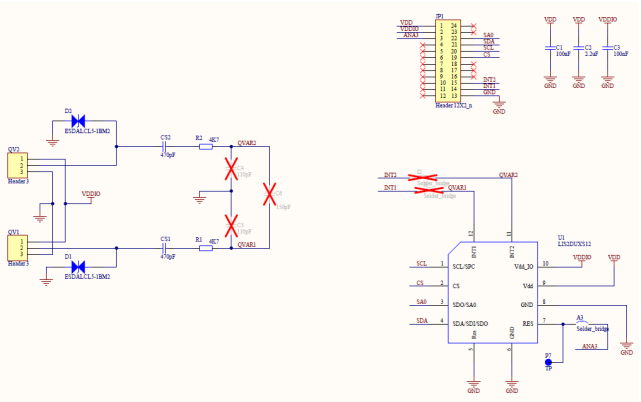
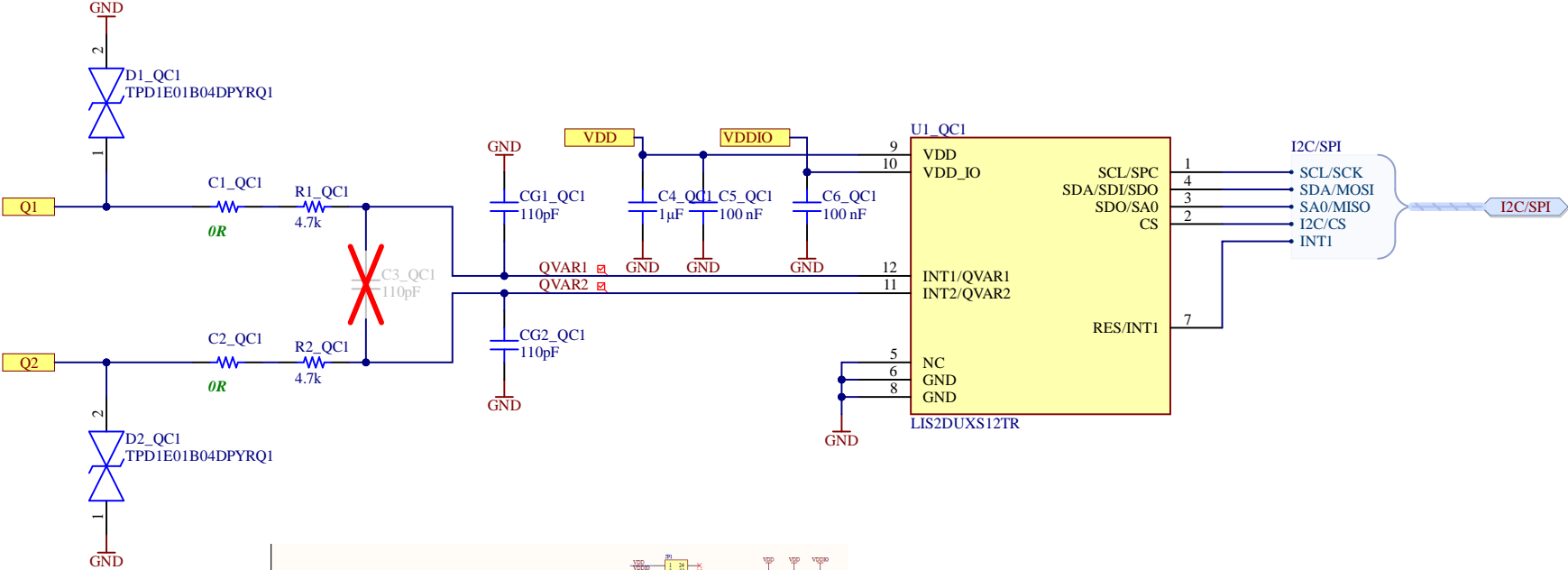




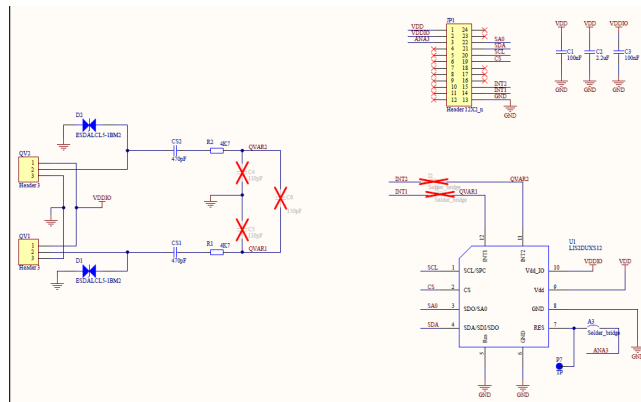
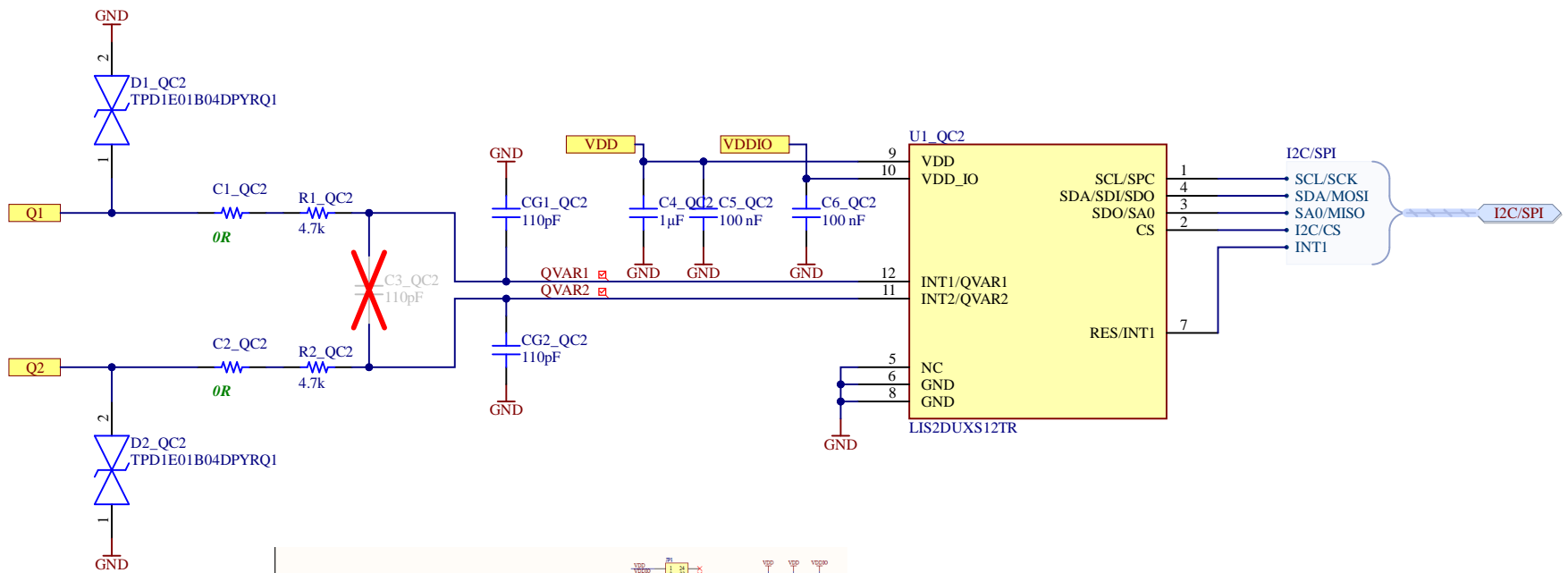
<b>ETH</b> Eidgenössische Technische Hochschule Zürich Swiss Federal Institute of Technology Zurich	Project: Qvar 6 Channel Vitalcore Backpack <b>QVAR sensor</b>	
	Laboratory: ETHZ D-ITET PBL, IIS	Drawn By: villanif
	Date: 17/11/2023 17:55:24 Rev: 1.0 Variation: Fabrication	Checked By: topononelli, nschae, peterste
File: QVAR.SchDoc		Sheet: 3 / 3



<b>ETH</b> Eidgenössische Technische Hochschule Zürich Swiss Federal Institute of Technology Zurich	Project: Qvar 6 Channel Vitalcore Backpack	
	QVAR sensor	
	Laboratory: ETHZ D-ITET PBL, IIS	
Date: 17/11/2023 17:55:24		Drawn By: villanif
Rev: 1.0		
Variation: Fabrication		
File: QVAR.SchDoc		Checked By: topononelli, nschae, peterste
		Sheet: 3 / 3



<b>ETH</b> Eidgenössische Technische Hochschule Zürich Swiss Federal Institute of Technology Zurich	Project: Qvar 6 Channel Vitalcore Backpack	
	QVAR sensor	
	Laboratory: ETHZ D-ITET PBL, IIS	
Date: 17/11/2023 17:55:24	Drawn By: villanif Checked By: topononelli, nschae, peterste	
Rev: 1.0		
Variation: Fabrication		
File: QVAR.SchDoc	Sheet: 3 / 3	



**ETH**

Eidgenössische Technische Hochschule Zürich  
Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL, IIS

Date: 17/11/2023 17:55:24

Rev: 1.0

Variation: Fabrication

File: QVAR.SchDoc

Project: Qvar 6 Channel Vitalcore Backpack

**QVAR sensor**

Drawn By: villanif

Checked By: topononelli, nschae, peterste

Sheet: 3 / 3



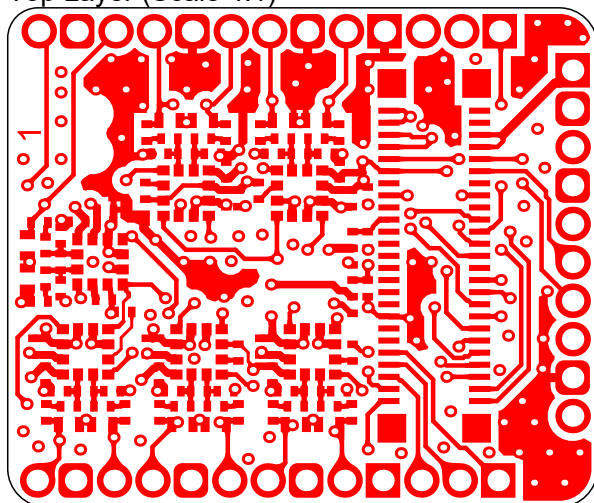
A

B

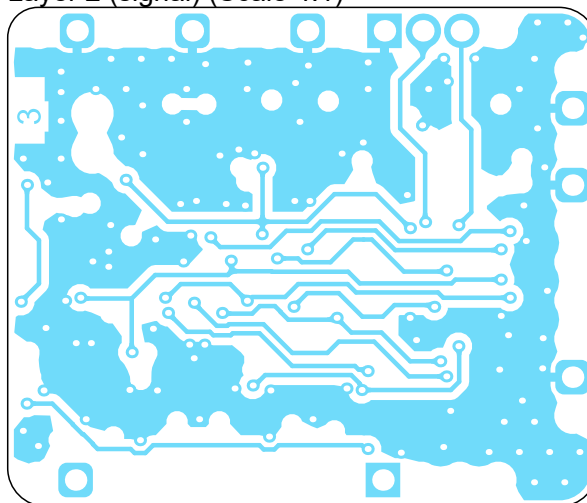
C

D

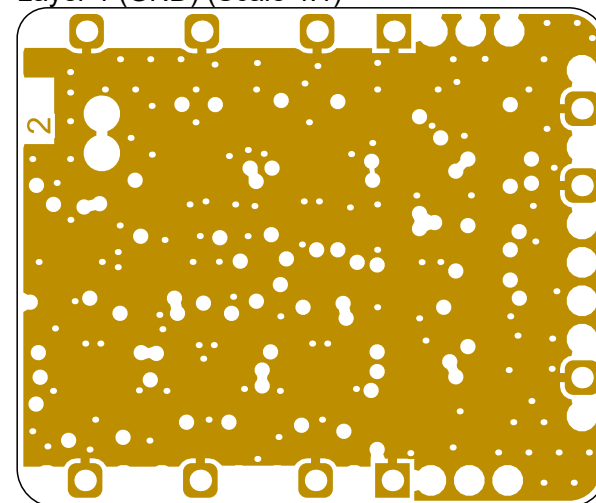
Top Layer (Scale 4:1)



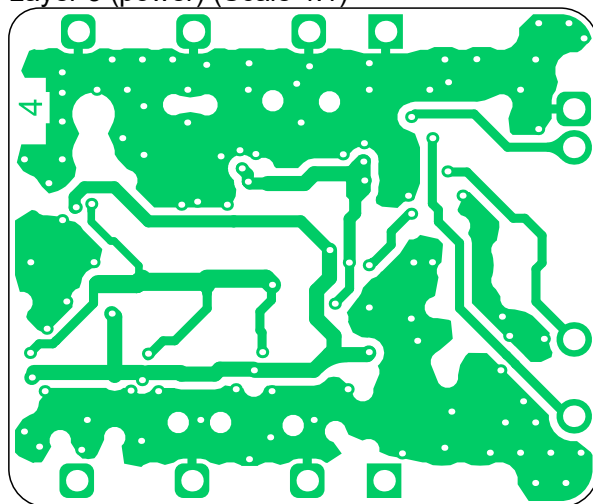
Layer 2 (signal) (Scale 4:1)



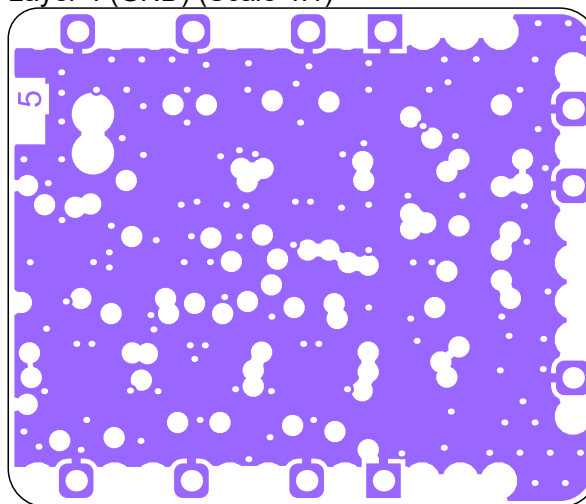
Layer 1 (GND) (Scale 4:1)



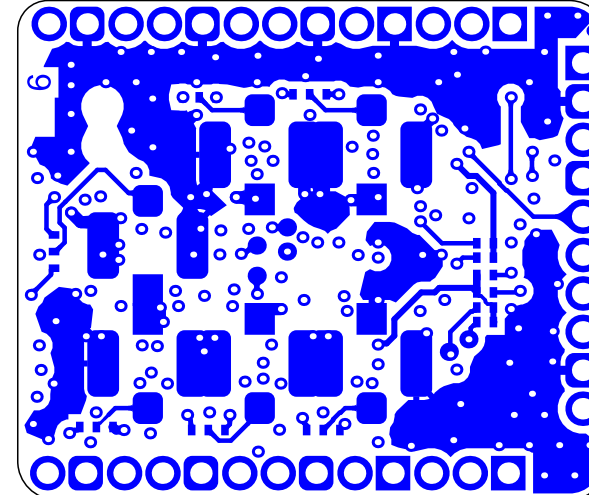
Layer 3 (power) (Scale 4:1)



Layer 4 (GND) (Scale 4:1)



Bottom Layer (Scale 4:1)

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Laboratory: ETHZ D-ITET PBL

Date: 17/11/2023 17:55

Revision: 1.0

Variant: [No Variations]

File: DOC\_ART.PCBDwf

Project: Qvar 6 Channel Vitalcore Backpack

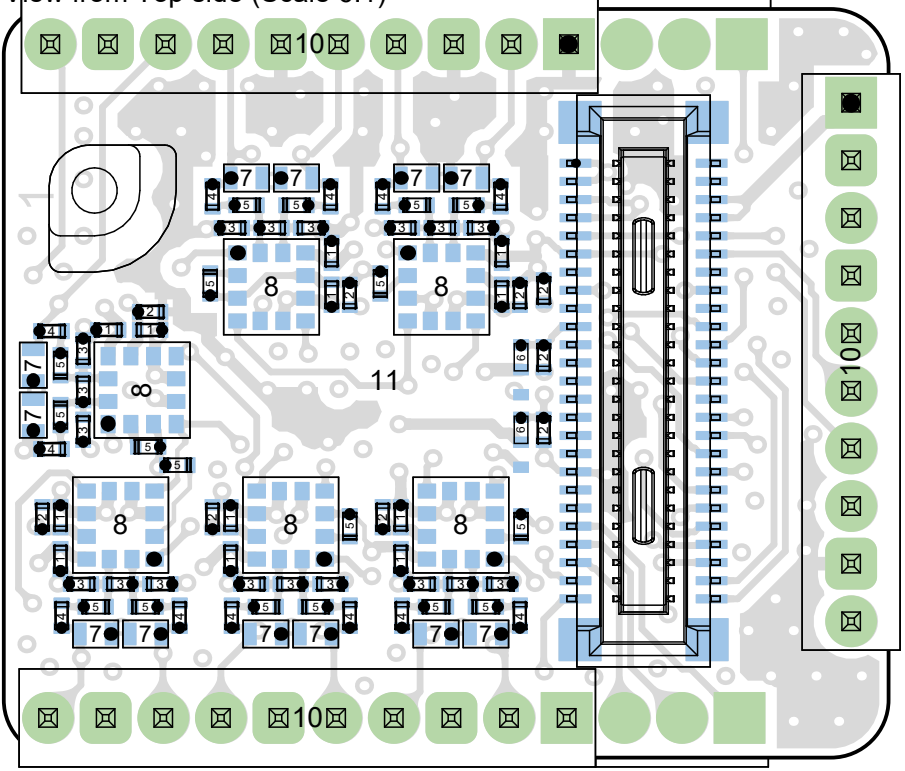
Art

Drawn By: villanif

Checked By: topononelli, nschae, peterste

Sheet: 1/1

View from Top side (Scale 6:1)



Eidgenössische Technische Hochschule Zürich  
Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL  
Date: 17/11/2023 17:56  
Revision: 1.0  
Variant: [No Variations]  
File: DOC\_ASSEMBLY.PCBDwf

Project: Qvar 6 Channel Vitalcore Backpack

Assembly

Drawn By: villanif  
Checked By: topolonelli, nschae, peterste

A

B

C

D

1

1

2

2

3

3

4

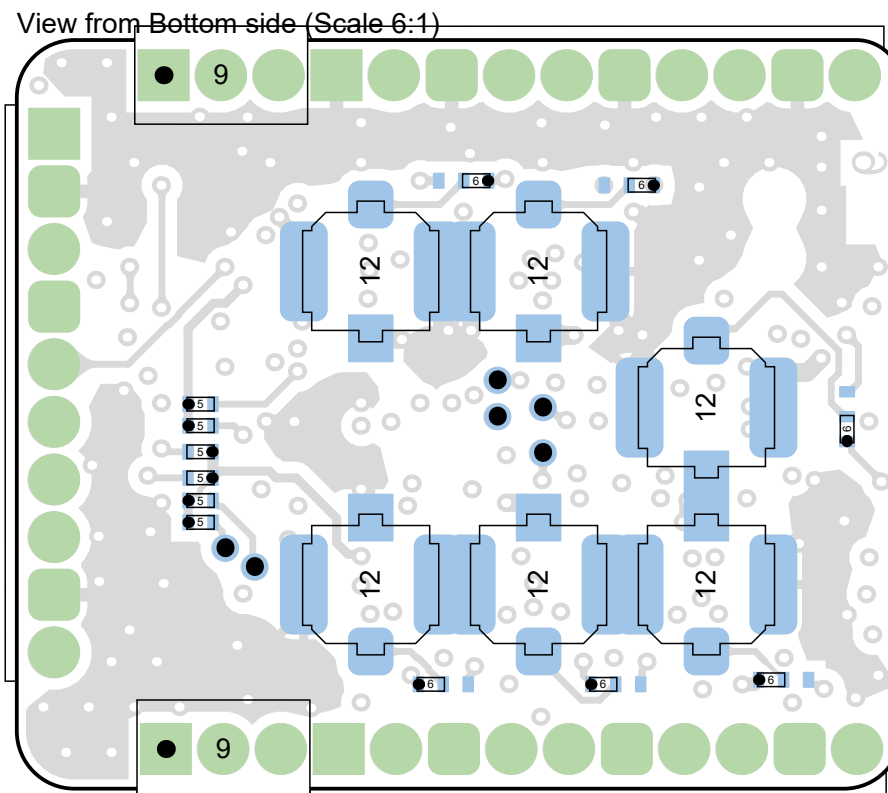
4

A

B

C

D

**ETH**

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Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL

Date: 17/11/2023 17:56

Revision: 1.0

Variant: [No Variations]

File: DOC\_ASSEMBLY.PCBDwf

Project: Qvar 6 Channel Vitalcore Backpack

Assembly

Drawn By: villanif

Checked By: topononelli, nschae, peterste

Sheet: 2/2

A

B

C

D

1

1

2

2

3

3

4

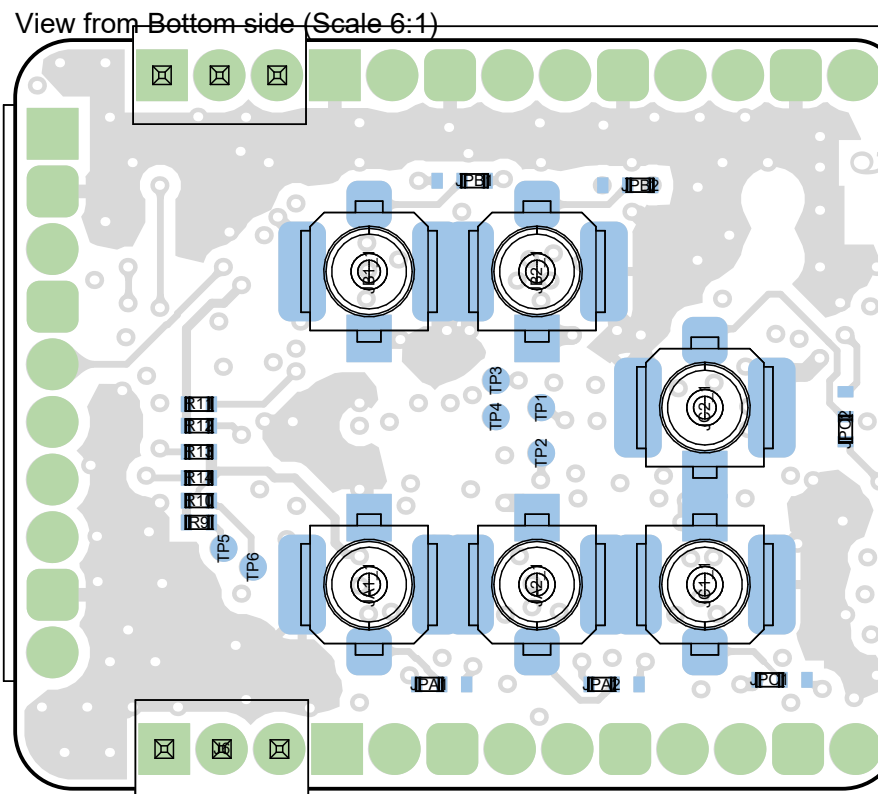
4

A

B

C

D

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Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL

Date: 17/11/2023 17:56

Revision: 1.0

Variant: [No Variations]

File: DOC\_CONN.PCBDwf

Project: Qvar 6 Channel Vitalcore Backpack

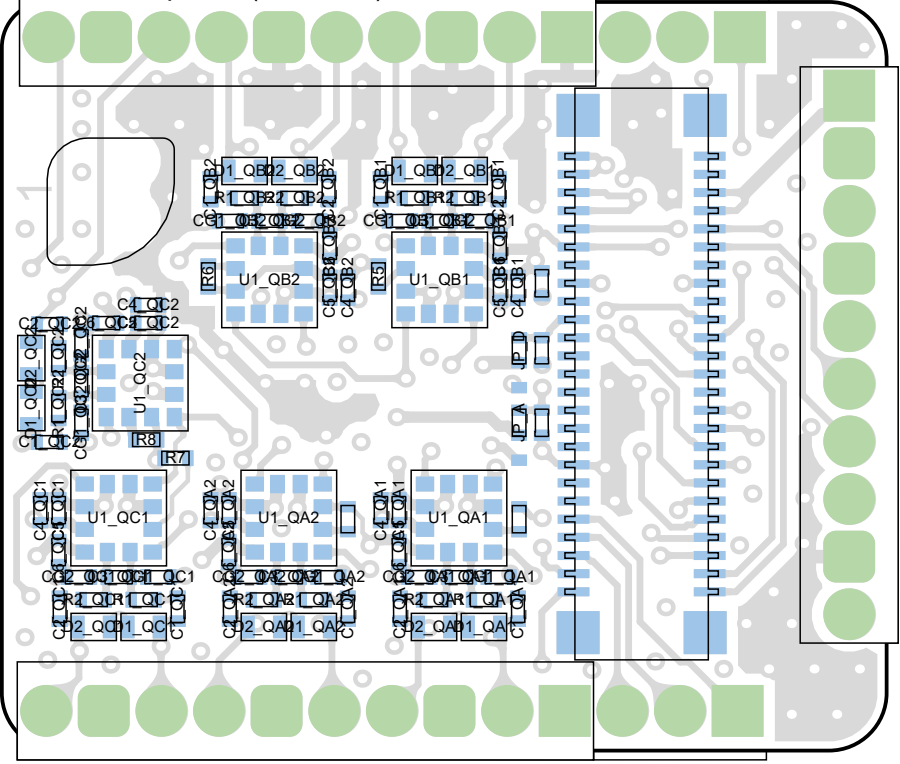
**Connectors**

Drawn By: villanif

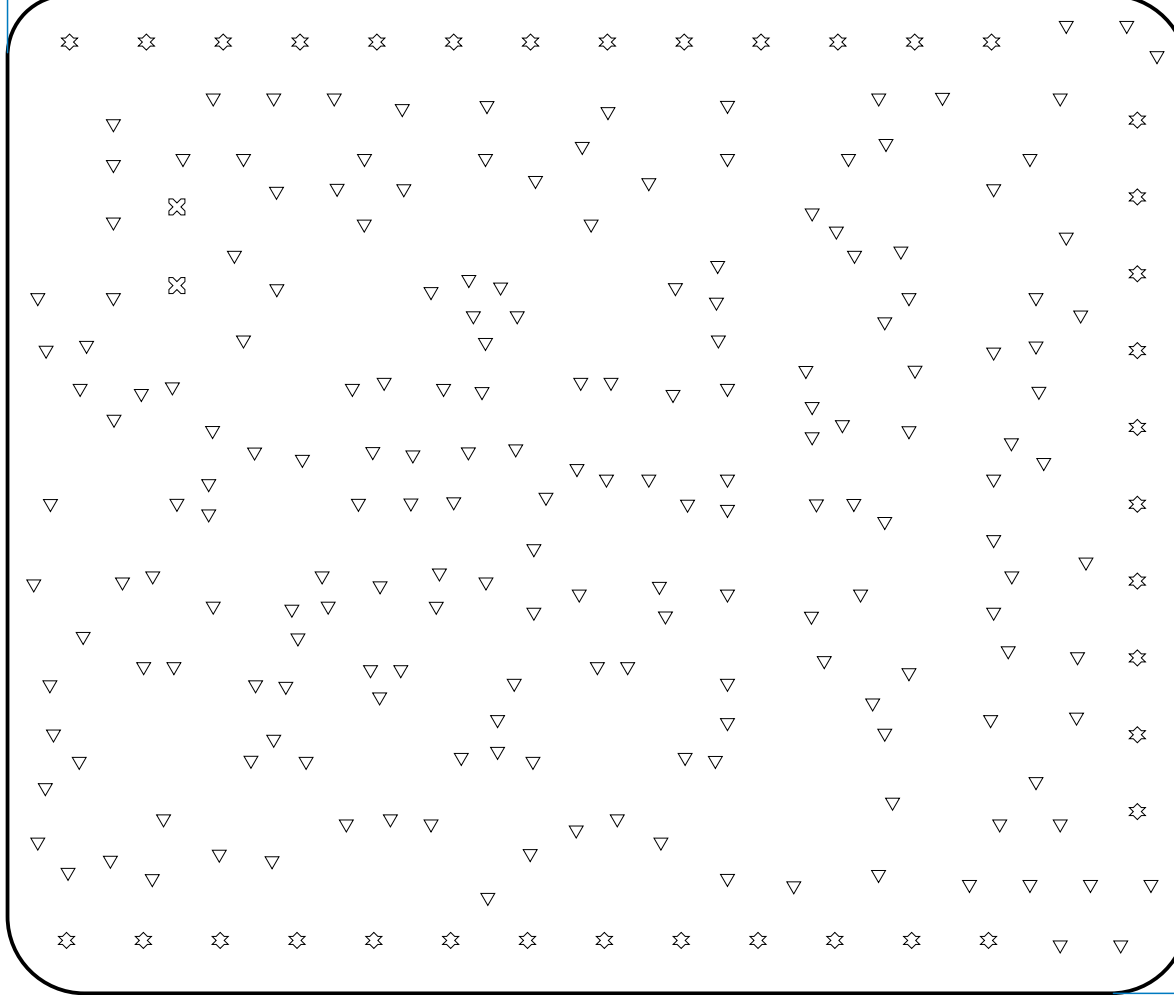
Checked By: topononelli, nschae, peterste

Sheet: 1/2

View from Top side (Scale 6:1)



Drill Drawing View (Scale 8:1)



Drill Table

Symbol	Count	Hole Size	Plated	Drill Layer Pair
▽	193	0.20mm	Plated	Top Layer - Bottom Layer
☆	36	0.71mm	Plated	Top Layer - Bottom Layer
⊗	2	0.90mm	Non-Plated	Top Layer - Bottom Layer
231 Total				

<b>ETH</b> Eidgenössische Technische Hochschule Zürich Swiss Federal Institute of Technology Zurich	Project: Qvar 6 Channel Vitalcore Backpack
	<b>Manufacturing</b>
Laboratory: ETHZ D-ITET PBL	Drawn By: villanif
Date: 17/11/2023 17:56	Checked By: topononelli, nschae, peterste
Revision: 1.0	
Variant: [No Variations]	
File: DOC_MANUFACTURE.PCBDwf	Sheet: 1/2

A

B

C

D

Layer Stack Legend

Layer	Type	Gerber	Thickness
Board Layer Stack Top Solder	Solder Mask	GTS	0.025mm
Top Surface Finish	Surface Finish		0.004mm
Top Layer	Signal	GTL	0.035mm
	Dielectric		0.099mm
Layer 1 (GND)	Signal	G1	0.015mm
	Dielectric		0.350mm
Layer 2 (signal)	Signal	G2	0.015mm
	Dielectric		0.109mm
Layer 3 (power)	Signal	G3	0.015mm
	Dielectric		0.350mm
Layer 4 (GND)	Signal	G4	0.015mm
	Dielectric		0.099mm
Bottom Layer	Signal	GBL	0.035mm
Bottom Surface Finish	Surface Finish		0.004mm
Board Layer Stack Bottom Solder	Solder Mask	GBS	0.025mm

NOTES:

- Via in pad
- 0.8mm Board: Use JLCPCB standard stackup
- ENIG finish.

<div><div><div>ETH</div><div>Eidgenössische Technische Hochschule Zürich</div><div>Swiss Federal Institute of Technology Zurich</div></div></div>	Project: Qvar 6 Channel Vitalcore Backpack
	Manufacturing
Laboratory: ETHZ D-ITET PBL	Drawn By: villanif
Date: 17/11/2023 17:56	Checked By: topononelli, nschae, peterste
Revision: 1.0	
Variant: [No Variations]	
File: DOC_MANUFACTURE.PCBDwf	Sheet: 2/2

A

B

C

D

A

B

C

D

## Bill Of Materials

Line #	Designator	Name	Quantity	Design Item Id	Manufacturer	Manufacturer Part Number
1	C5_QA1, C5_QA2, C5_QB1, C5_QB2, C5_QC1, C5_QC2, C6_QA1, C6_QA2, C6_QB1, C6_QB2, C6_QC1, C6_QC2	100 nF	12	CAP_0201_100n_10V	Murata	GRM033R6YA104ME14D
2	C4_QA1, C4_QA2, C4_QB1, C4_QB2, C4_QC1, C4_QC2, C7, C8, C9	1µF	9	CAP_0201_1u_10V	Murata	GRM033C81A105ME05D
3	C3_QA1, C3_QA2, C3_QB1, C3_QB2, C3_QC1, C3_QC2, CG1_QA1, CG1_QA2, CG1_QB1, CG1_QB2, CG1_QC1, CG1_QC2, CG2_QA1, CG2_QA2, CG2_QB1, CG2_QB2, CG2_QC1, CG2_QC2	110pF	18	CAP_0201_110p_50V	Murata	GRM0335C1H111JA01D
4	C1_QA1, C1_QA2, C1_QB1, C1_QB2, C1_QC1, C1_QC2, C2_QA1, C2_QA2, C2_QB1, C2_QB2, C2_QC1, C2_QC2	470pF	12	CAP_0201_470p_25V	Murata	GRM0335C1E471JA01D
5	R1_QA1, R1_QA2, R1_QB1, R1_QB2, R1_QC1, R1_QC2, R2_QA1, R2_QA2, R2_QB1, R2_QB2, R2_QC1, R2_QC2, R3, R4, R5, R6, R7, R8, R9, R10, R11, R12, R13, R14	4.7k	24	R_0201_4.7K	Panasonic	ERJ-1GNF4701C
6	JP_A, JP_D, JPA1, JPA2, JPB1, JPB2, JPC1, JPC2	JMP	8	JMP_0201_3w	Panasonic	ERJ-1GN0R00C
7	D1_QA1, D1_QA2, D1_QB1, D1_QB2, D1_QC1, D1_QC2, D2_QA1, D2_QA2, D2_QB1, D2_QB2, D2_QC1, D2_QC2	TPD1E01B04DPYRQ1	12	TPD1E01B04DPYRQ1	Texas Instruments	TPD1E01B04DPYRQ1
8	U1_QA1, U1_QA2, U1_QB1, U1_QB2, U1_QC1, U1_QC2	LIS2DUXS12TR	6	LIS2DUXS12TR	STMicroelectronics	LIS2DUXS12TR
9	J5, J6	FTS-103-01-L-S	2	FTS-103-01-L-S	Samtec	FTS-103-01-L-S
10	J2, J3, J4	FTS-110-01-L-S	3	FTS-110-01-L-S	Samtec	FTS-110-01-L-S
11	J1	VitalCore Interface v1.0	1	BACKPACK_INTERFACE_V1.0	Hirose	DF40C(2.0)-50DS-0.4V(51)
12	JA1_1, JA2_1, JB1_1, JB2_1, JC1_1, JC2_1	CONMHF1-SMD-G-T	6	CONMHF1-SMD-G-T	TE Connectivity	CONMHF1-SMD-G-T

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Swiss Federal Institute of Technology Zurich

Laboratory: ETHZ D-ITET PBL

Date: 17/11/2023 17:56

Revision: 1.0

Variant: [No Variations]

File: DOC\_BOM.PCBDwf

Project: Qvar 6 Channel Vitalcore Backpack

**BOM**

Drawn By: villanif

Checked By: topolonelli, nschae, peterste

Sheet: 1/1

A

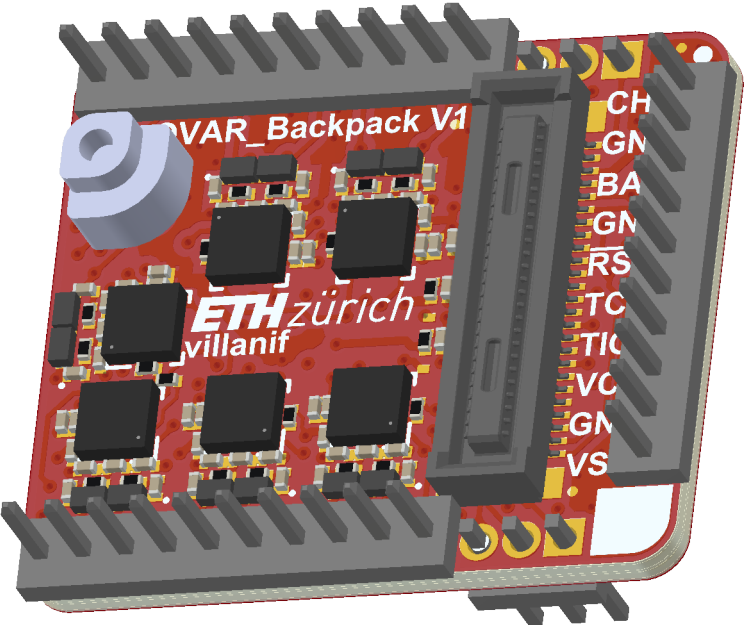
B

C

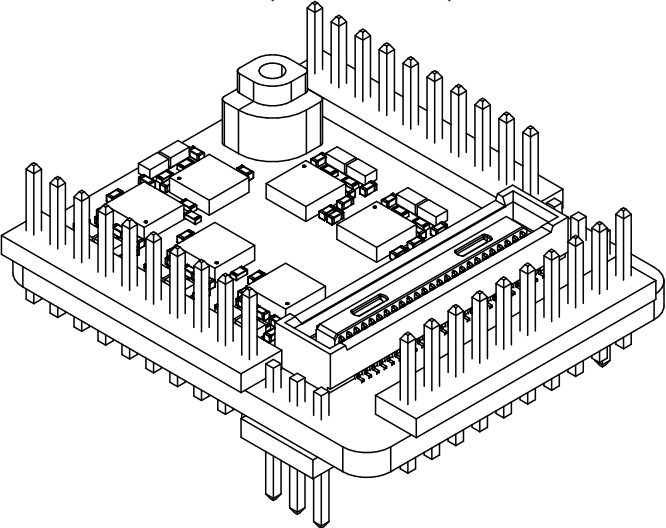
D



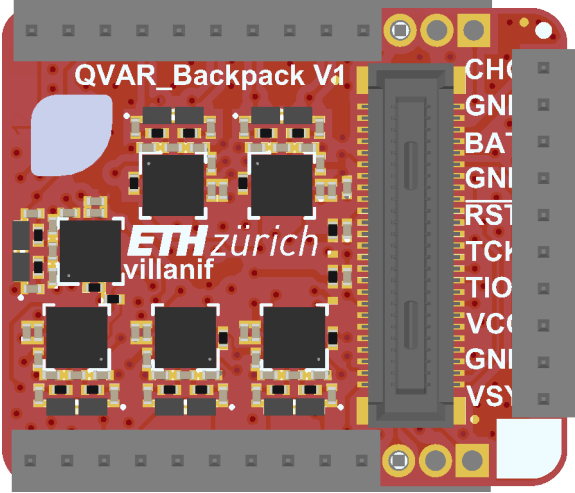
Realistic View



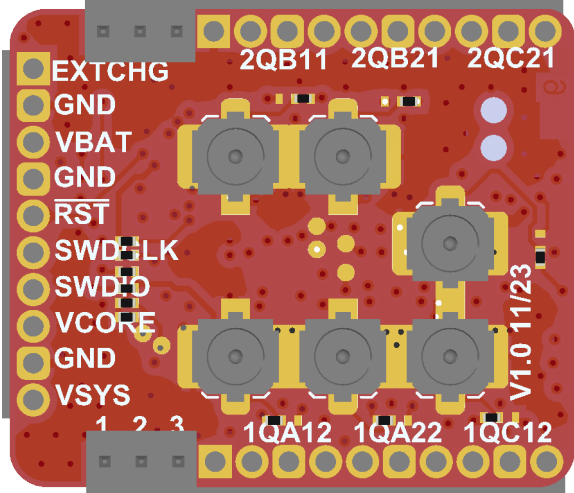
View from Front side (Scale 3.528:1)



Realistic View



Realistic View



<div><div><div>ETH</div><div>Eidgenössische Technische Hochschule Zürich</div><div>Swiss Federal Institute of Technology Zurich</div></div></div>		<div>Project: Qvar 6 Channel Vitalcore Backpack</div> <div>3D Render</div> <div>Drawn By: villanif</div> <div>Checked By: topononelli, nschae, peterste</div>
Laboratory: ETHZ D-ITET PBL		
Date: 17/11/2023 17:57		
Revision: 1.0		
Variant: [No Variations]		
File: DOC_3D.PCBDwf		

Sheet: 1/1